TOSHIBA Field-Effect Transistor Silicon P-Channel MOS Type (U-MOSVI)

SSM3J56MFV

O Load Switching Applications

- 1.2 V drive
- Low ON-resistance: $R_{DS(ON)}$ = 390 m Ω (max) (@V_{GS} = -4.5 V)
 - $R_{DS(ON)} = 480 \text{ m}\Omega \text{ (max)} (@V_{GS} = -2.5 \text{ V})$
 - $R_{DS(ON)} = 660 \text{ m}\Omega \text{ (max)} (@V_{GS} = -1.8 \text{ V})$
 - $R_{DS(ON)} = 900 \text{ m}\Omega \text{ (max)} (@V_{GS} = -1.5 \text{ V})$

 $R_{DS(ON)} = 4000 \text{ m}\Omega \text{ (max)} (@V_{GS} = -1.2 \text{ V})$

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol		Rating	Unit	
Drain-Source voltage		V _{DSS}		-20	V	
Gate-Source voltage		V _{GSS}		± 8	V	
Drain current	DC	I _D (Note 1)		-800	mA	
	Pulse	I _{DP} (Note 1)		-1600	ШA	
Power dissipation		P _D (Note 2)		150	mW	
		P _D (Note 3)		500		
			t < 5s	800		
Channel temperature		T _{ch}		150	°C	
Storage temperature range		T _{stg}		–55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: The channel temperature should not exceed 150°C during use.

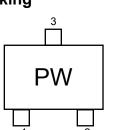
Note 2: Mounted on a FR4 board.

Note 3: Mounted on a FR4 board.

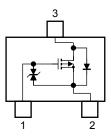
(25.4 mm × 25.4 mm × 1.6 mm, Cu Pad: 0.585 mm²)

(25.4 mm × 25.4 mm × 1.6 mm, Cu Pad: 645 mm²)

Marking



Equivalent Circuit (top view)

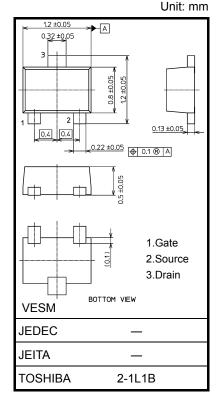


Handling Precaution

When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

Thermal resistance Rth (ch-a) and Power dissipation PD vary depending on board material, board area, board thickness and pad area. When using this device, please take heat dissipation into consideration.

> Start of commercial production 2011-05



Weight: 1.5mg (typ.)

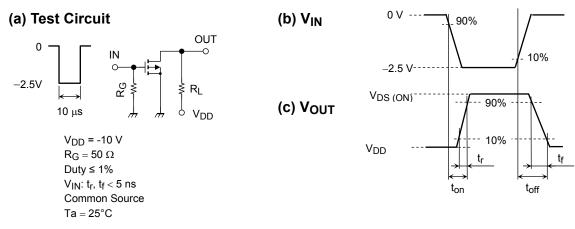
Electrical Characteristics (Ta = 25°C)

Chara	cteristic	Symbol	Test Conditions		Min	Тур.	Max	Unit
Drain-source breakdown voltage		V (BR) DSS	I _D = -1 mA, V _{GS} = 0 V		-20	—	—	V
		V (BR) DSX	I _D = -1 mA, V _{GS} = 5 V	(Note 5)	-15	—		V
Drain cut-off current		I _{DSS}	V_{DS} = -20 V, V_{GS} = 0 V		_	_	-1	μA
Gate leakage current		I _{GSS}	V_{GS} = ±8 V, V_{DS} = 0 V		_		±1	μA
Gate threshold voltage		V _{th}	V _{DS} = -3 V, I _D = -1 mA		-0.3	—	-1.0	V
Forward transfer admittance		Y _{fs}	V _{DS} = -3 V, I _D = -100 mA	(Note 4)	0.5	1.0		S
		I _D = -800 mA, V _{GS} = -4.5 V	(Note 4)	_	310	390	mΩ	
Drain–source ON-resistance			I _D = -500 mA, V _{GS} = -2.5 V	(Note 4)	_	380		480
		R _{DS (ON)}	I _D = -200 mA, V _{GS} = -1.8 V	(Note 4)	_	470		660
			I _D = -100 mA, V _{GS} = -1.5 V	(Note 4)	_	560		900
			I _D = -10 mA, V _{GS} = -1.2 V	(Note 4)	_	770		4000
Input capacitance		C _{iss}			_	100		
Output capacitance		Coss	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz		_	16		pF
Reverse transfer capacitance		C _{rss}			_	10		
Switching time	Turn-on time	t _{on}	V _{DD} = -10 V, I _D = -200 mA		_	8		ns
	Turn-off time	t _{off}	V_{GS} = 0 to -2.5 V, R_{G} = 50 Ω	_	26			
Total gate charge		Qg	(, -, -, -, -, -, -, -, -, -, -, -, -,		_	1.6	—	
Gate-source charge		Q _{gs1}	$V_{DD} = -10 \text{ V}, \text{ I}_{D} = -800 \text{ mA},$		_	0.2	—	nC
Gate-drain charge		Q _{gd}	V _{GS} = -4.5 V		_	0.4	—	
Drain-source forward voltage		V _{DSF}	I _D = 800 mA, V _{GS} = 0 V	(Note 4)	_	0.9	1.2	V

Note 4: Pulse test

Note 5: If a forward bias is applied between gate and source, this device enters V(BR)DSX mode. Note that the drain-source breakdown voltage is lowered in this mode.

Switching Time Test Circuit

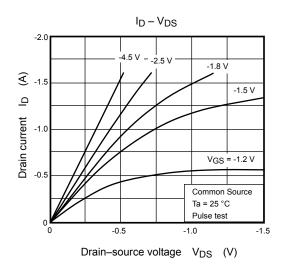


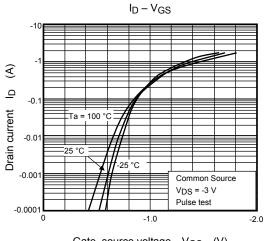
Notice on Usage

 V_{th} can be expressed as the voltage between gate and source when the low operating current value is $I_D = -1$ mA for this product. For normal switching operation, $V_{GS (on)}$ requires a higher voltage than V_{th} and $V_{GS (off)}$ requires a lower voltage than V_{th} . (The relationship can be established as follows: $V_{GS (off)} < V_{th} < V_{GS (on)}$.)

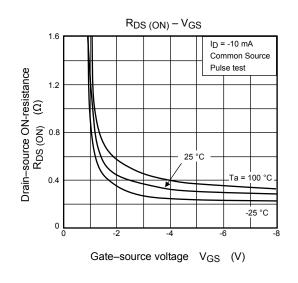
Take this into consideration when using the device.

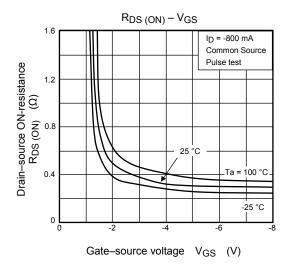
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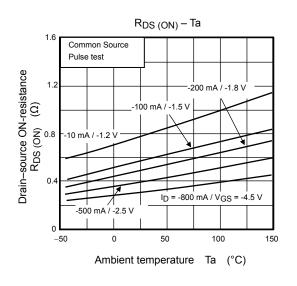


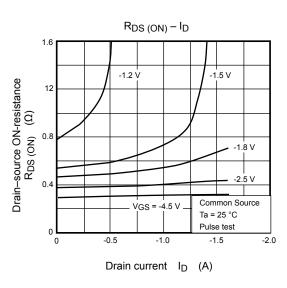


Gate-source voltage V_{GS} (V)

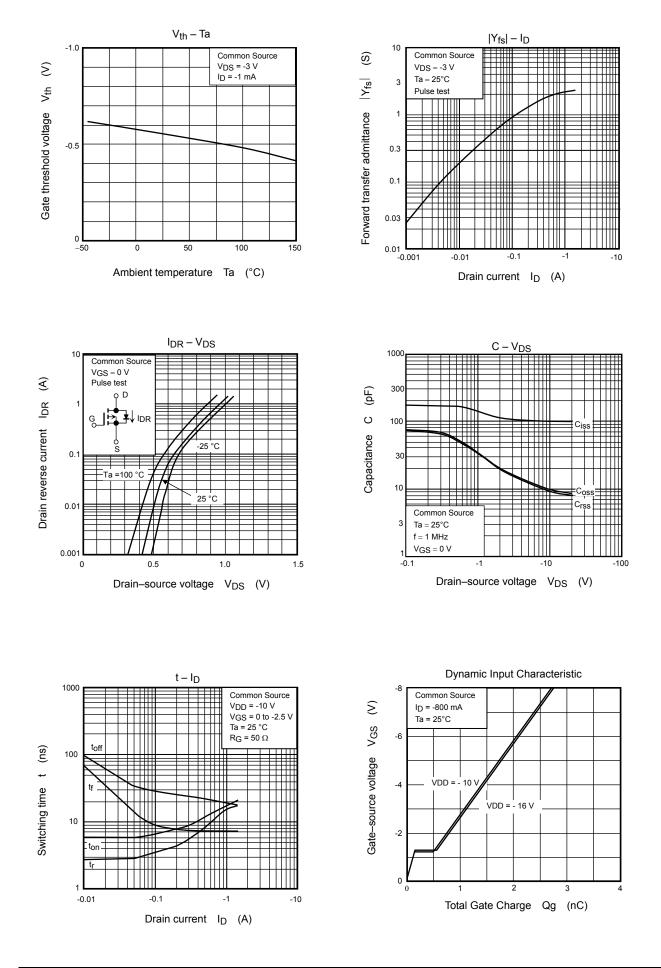




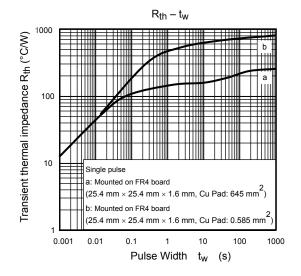


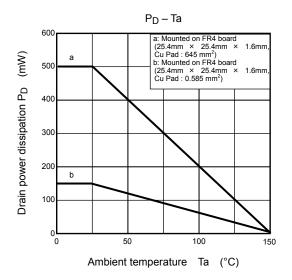


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